

### **Dual Voltage Detector with Adjustable Hysteresis**

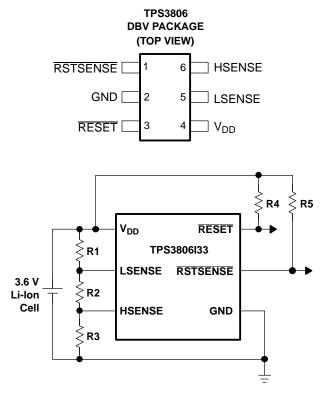
#### **FEATURES**

- Dual Voltage Detector With Adjustable Hysteresis 3.3-V/Adjustable and 2-V/Adjustable
- Assured Reset at V<sub>DD</sub> = 0.8 V
- Supply Current: 3 μA Typical at V<sub>DD</sub> = 3.3 V
- Independent Open-Drain Reset Outputs
- Temperature Range: -40°C to +85°C
- 6-Pin SOT-23 Package

#### **DESCRIPTION**

The TPS3806 integrates two independent voltage detectors for battery voltage monitoring. During power-on, RESET and RSTSENSE are asserted when supply voltage V<sub>DD</sub> or the voltage at LSENSE input become higher than 0.8 V. Thereafter, the supervisory circuit monitors VDD and LSENSE, keeping RESET and RSTSENSE active as long as V<sub>DD</sub> and LSENSE remain below the threshold voltage, V<sub>IT</sub>. As soon as  $V_{DD}$  or LSENSE rise above the threshold voltage  $V_{IT}$ , RESET or RSTSENSE is deasserted, respectively. The TPS3806 device has a fixed-sense threshold voltage VIT set by an internal voltage divider at V<sub>DD</sub> and an adjustable second-LSENSE input. In addition, an upper voltage threshold can be set at **HSENSE** to allow wide adjustable а hysteresis window.

The devices are available in a 6-pin SOT-23 package. The TPS3806 device is characterized for operation over a temperature range of -40°C to +85°C.



**Typical Operating Circuit** 



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





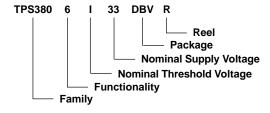
This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### ORDERING INFORMATION(1)

| т              | DEVICE                        | - NAME                        | THRESHOL        | D VOLTAGE | MARKING |
|----------------|-------------------------------|-------------------------------|-----------------|-----------|---------|
| I <sub>A</sub> | DEVICE                        | ENAME                         | V <sub>DD</sub> | SENSE     | WARKING |
| 40°C to 195°C  | TPS3806J20DBVR <sup>(2)</sup> | TPS3806J20DBVT <sup>(3)</sup> | 1.8 V           | 1.207 V   | PGQI    |
| -40°C to +85°C | TPS3806I33DBVR <sup>(2)</sup> | TPS3806I33DBVT <sup>(3)</sup> | 3 V             | 1.207 V   | PGPI    |

- (1) For the most current package and ordering information, see the Package Option Addendum located at the end of this data sheet or refer to our web site at www.ti.com.
- (2) The DBVR passive indicates tape and reel containing 3000 parts.
- (3) The DBVT passive indicates tape and reel containing 250 parts.



#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)(1)

|   | TPS3806J20, TPS3806I33       | UNIT |
|---|------------------------------|------|
| Supply voltage, V <sub>DD</sub> <sup>(2)</sup>  | 7                            | V    |
| All other pins <sup>(2)</sup>   | -0.3 to 7                    | V    |
| Maximum low-output current, I <sub>OL</sub>   | 5                            | mA   |
| Maximum high-output current, I <sub>OH</sub>  | -5                           | mA   |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>DD</sub> )  | ±10                          | mA   |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>DD</sub> ) | ±10                          | mA   |
| Continuous total power dissipation  | See Dissipation Rating Table |      |
| Operating free-air temperature range, T <sub>A</sub>  | -40 to +85                   | °C   |
| Storage temperature range, T <sub>stg</sub>   | -65 to +150                  | °C   |
| Soldering temperature   | +260                         | °C   |

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### **DISSIPATION RATING TABLE**

| PACKAGE | T <sub>A</sub> < 25°C | DERATING FACTOR<br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING |
|---------|-----------------------|--|---------------------------------------|---------------------------------------|
| DBV     | 437 mW                | 3.5 mW/°C                                      | 280 mW                                | 227 mW                                |

<sup>(2)</sup> All voltage values are with respect to GND. For reliable operation, the device must not be continuously operated at 7 V for more than t = 1000 h.



#### **RECOMMENDED OPERATING CONDITIONS**

|  | MIN | MAX                   | UNIT |
|--|-----|-----------------------|------|
| Supply voltage, V <sub>DD</sub>                      | 1.3 | 6                     | ٧    |
| Input voltage, V <sub>I</sub>                        | 0   | V <sub>DD</sub> + 0.3 | ٧    |
| Operating free-air temperature range, T <sub>A</sub> | -40 | +85                   | °C   |

#### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range (unless otherwise noted)

| PARA            | AMETER  |   | TEST CONDITIONS                                      | MIN   | TYP   | MAX   | UNIT |
|-----------------|---|---|--|-------|-------|-------|------|
|                 |   |   | V <sub>DD</sub> = 1.5 V, I <sub>OL</sub> = 1 mA      |       |       |       |      |
| $V_{OL}$        | Low-level output voltage  | ow-level output voltage $V_{DD} = 3.3 \text{ V}, I_{OL} = 2 \text{ mA}$             |  |       |       | 0.3   | V    |
|                 |   |   | V <sub>DD</sub> = 6 V, I <sub>OL</sub> = 3 mA        |       |       |       |      |
|                 | Power-up reset voltage <sup>(1)</sup>                                 |   | $V_{DD} \ge 0.8 \text{ V}, I_{OL} = 50  \mu\text{A}$ |       |       | 0.2   | V    |
|                 |   | LSENSE  |  | 1.198 | 1.207 | 1.216 |      |
|                 | V <sub>IT</sub> Negative-going input threshold voltage <sup>(2)</sup> | TPS3806J20  | $T_A = +25^{\circ}C$                                 | 1.787 | 1.8   | 1.813 | V    |
|                 |   | TPS3806l33  |  | 2.978 | 3.0   | 3.022 |      |
|                 |   | LSENSE  |  | 1.188 | 1.207 | 1.226 | V    |
| $V_{\text{IT}}$ |   | legative-going TPS3806J20 $T_A = 0^{\circ}\text{C} \text{ to } +70^{\circ}\text{C}$ | $T_A = 0$ °C to +70°C                                | 1.772 | 1.8   | 1.828 |      |
|                 |   | TPS3806I33  |  | 2.952 | 3.0   | 3.048 |      |
|                 |   | LSENSE  |  | 1.183 | 1.207 | 1.231 |      |
|                 |   | TPS3806J20 T  |  | 1.764 | 1.8   | 1.836 | V    |
|                 |   | TPS3806l33  |  | 2.94  | 3.0   | 3.06  |      |
| \/              | Lhyotoropio   | ·   | 1.2 V < V <sub>IT</sub> < 2.5 V                      |       | 60    |       | mV   |
| $V_{hys}$       | Hysteresis  |   | 2.5 V < V <sub>IT</sub> < 3.5 V                      |       | 90    |       | mv   |
| I               | Input current   | LSENSE, HSENSE  |  | -25   |       | 25    | nA   |
| $I_{OH}$        | High-level output current   |   | $V_{DD} = V_{IT} + 0.2 \text{ V}, V_{OH} = V_{DD}$   |       |       | 300   | nA   |
|                 | Cupply gurrant  |   | V <sub>DD</sub> = 3.3 V, Output unconnected          |       | 3     | 5     |      |
| I <sub>DD</sub> | Supply current  |   | V <sub>DD</sub> = 6 V, Output unconnected            |       | 4     | 6     | μΑ   |
| Ci              | Input capacitance   |   | V <sub>I</sub> = 0 V to V <sub>DD</sub>              |       | 1     |       | pF   |

#### **SWITCHING CHARACTERISTICS**

at R<sub>L</sub> = 1 M $\Omega$ , C<sub>L</sub> = 50 pF, T<sub>A</sub> = -40°C to +85°C

| PARA  | METER                     | TEST CONDITIONS                | MIN                           | TYP | MAX | UNIT |     |
|---|---------------------------|--------------------------------|-------------------------------|-----|-----|------|-----|
| t <sub>PHL</sub> Propagation (delay) time, high-to-low-level output |                           | V <sub>DD</sub> to RESET delay |                               |     | _   | 100  | 110 |
|   |                           | LSENSE to RSTSENSE delay       | $V_{IH} = 1.05 \times V_{IT}$ |     | 5   | 100  | μs  |
|   | Propagation (delay) time, | V <sub>DD</sub> to RESET delay | $V_{IL} = 0.95 \times V_{IT}$ |     | -   | 100  |     |
| <sup>L</sup> PLH  | low-to-high-level output  | HSENSE to RSTSENSE delay       |                               |     | Э   | 100  | μs  |

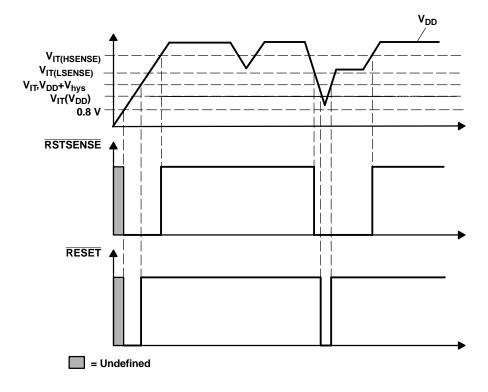
#### **TIMING REQUIREMENTS**

at R<sub>L</sub> = 1 M $\Omega$ , C<sub>L</sub> = 50 pF, T<sub>A</sub> = -40°C to +85°C

| PARAMETER      |                            |                    | TEST CONDITIONS  | MIN | TYP | MAX | UNIT |
|----------------|----------------------------|--------------------|--|-----|-----|-----|------|
|                | Pulso width                | At V <sub>DD</sub> | V - 105 x V V - 0.05 x V                                   | E   |     |     |      |
| ι <sub>w</sub> | t <sub>w</sub> Pulse width | At SENSE           | $V_{IH} = 1.05 \times V_{IT}, V_{IL} = 0.95 \times V_{IT}$ | 5.5 |     |     | μs   |

 <sup>(1)</sup> The lowest supply voltage at which RESET becomes active. t<sub>r,VDD</sub> ≥ 15 μs/V
 (2) To ensure best stability of the threshold voltage, place a bypass capacitor (ceramic, 0.1 μF) near the supply terminals.





**Table 1. TERMINAL FUNCTIONS** 

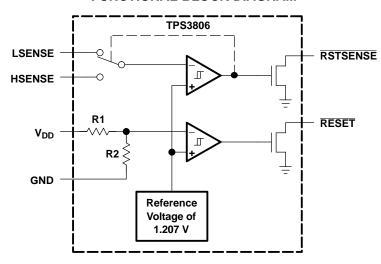
| TERI     | TERMINAL I/O |     | DESCRIPTION  |
|----------|--------------|-----|--|
| NAME     | NO.          | 1/0 | DESCRIPTION  |
| GND      | 2            | I   | Ground   |
| HSENSE   | 6            | I   | Adjustable hysteresis input                                |
| LSENSE   | 5            | I   | Adjustable sense input                                     |
| RESET    | 3            | 0   | Active-low open drain reset output (from V <sub>DD</sub> ) |
| RSTSENSE | 1            | 0   | Active-low open-drain reset output (from LSENSE)           |
| $V_{DD}$ | 4            | I   | Input supply voltage and fixed sense input                 |

### **FUNCTION/TRUTH TABLE**

| TPS3806   |   |   |   |  |  |  |  |  |  |  |
|---|---|---|---|--|--|--|--|--|--|--|
| V <sub>DD</sub> > V <sub>IT</sub> RESET LSENSE > V <sub>IT</sub> RSTSENSE |   |   |   |  |  |  |  |  |  |  |
| 0   | L | 0 | L |  |  |  |  |  |  |  |
| 1   | Н | 1 | Н |  |  |  |  |  |  |  |



#### **FUNCTIONAL BLOCK DIAGRAM**



#### **Detailed Description**

#### Operation

The TPS3806 is used for monitoring battery voltage and asserting  $\overline{\text{RESET}}$  when a battery gets discharged below a certain threshold voltage. The battery voltage is monitored by a comparator via an external resistor divider. When the voltage at the LSENSE input drops below the internal reference voltage the  $\overline{\text{RSTSENSE}}$  output pulls low. The output remains low until the battery is replaced, or recharged above a second higher trip-point, set at HSENSE. A second voltage can be monitored at  $V_{DD}$ . The independent  $\overline{\text{RESET}}$  output pulls low when the voltage at  $V_{DD}$  drops below the fixed threshold voltage. Because the TPS3806 outputs are open-drain MOSFETs, most applications may require a pull-up resistor.

#### **Programming the Threshold Voltage Levels**

The low-voltage threshold at LSENSE is calculated according to Equation 1:

$$V_{(LSENSE)} = V_{ref} \left( \frac{R1 + R2 + R3}{R2 + R3} \right)$$
(1)

where  $V_{ref} = 1.207 \text{ V}$ 

The high-voltage threshold at HSENSE is calculated as shown in Equation 2:

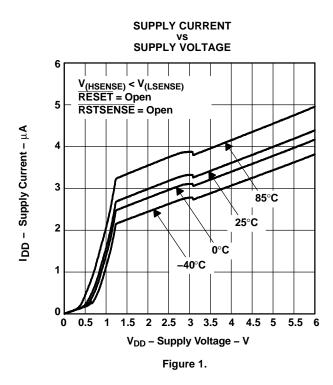
$$V_{(HSENSE)} = V_{ref} \left( \frac{R1 + R2 + R3}{R3} \right)$$
 (2)

where  $V_{ref} = 1.207 \text{ V}$ 

To minimize battery current draw it is recommended to use 1-M $\Omega$  as the total resistor value  $R_{(tot)}$ , with  $R_{(tot)} = R1 + R2 + R3$ .



#### TYPICAL CHARACTERISTICS



# LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

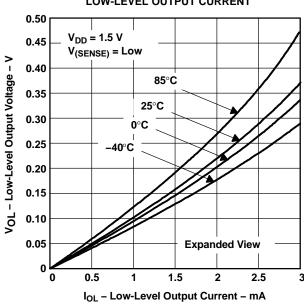


Figure 3.

# LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

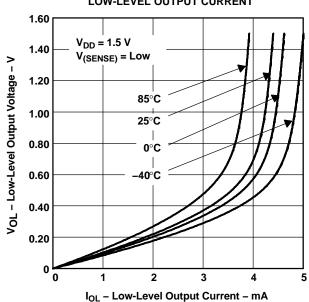


Figure 2.

# LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

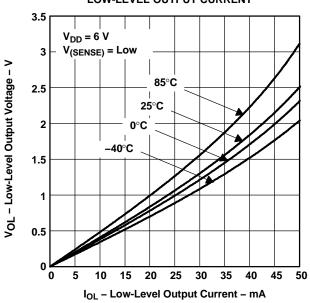


Figure 4.



#### **TYPICAL CHARACTERISTICS (continued)**

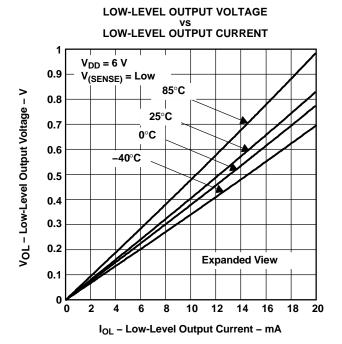
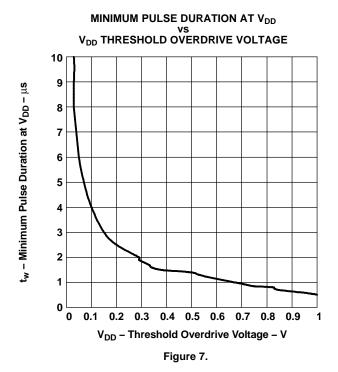


Figure 5.



## NORMALIZED INPUT THRESHOLD VOLTAGE vs FREE-AIR TEMPERATURE AT VDD

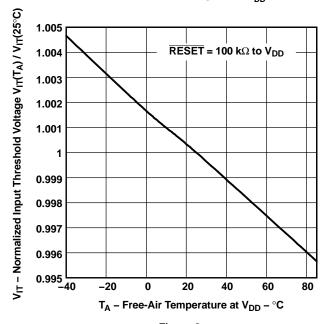


Figure 6.

## MINIMUM PULSE DURATION AT LSENSE VS LSENSE THRESHOLD OVERDRIVE VOLTAGE

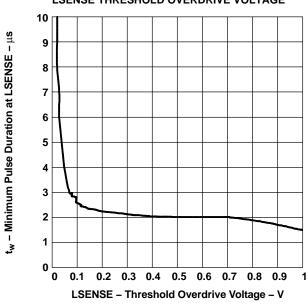


Figure 8.





i.com 18-Jul-2006

#### PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| TPS3806I33DBVR   | ACTIVE                | SOT-23          | DBV                | 6    | 3000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806I33DBVRG4 | ACTIVE                | SOT-23          | DBV                | 6    | 3000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806I33DBVT   | ACTIVE                | SOT-23          | DBV                | 6    | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806l33DBVTG4 | ACTIVE                | SOT-23          | DBV                | 6    | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806J20DBVR   | ACTIVE                | SOT-23          | DBV                | 6    | 3000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806J20DBVRG4 | ACTIVE                | SOT-23          | DBV                | 6    | 3000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806J20DBVT   | ACTIVE                | SOT-23          | DBV                | 6    | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| TPS3806J20DBVTG4 | ACTIVE                | SOT-23          | DBV                | 6    | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device         | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|-----------------|--------------------|---|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| TPS3806I33DBVR | SOT-23          | DBV                | 6 | 3000 | 179.0                    | 8.4                      | 3.2     | 3.2     | 1.4     | 4.0        | 8.0       | Q3               |
| TPS3806I33DBVT | SOT-23          | DBV                | 6 | 250  | 179.0                    | 8.4                      | 3.2     | 3.2     | 1.4     | 4.0        | 8.0       | Q3               |
| TPS3806J20DBVR | SOT-23          | DBV                | 6 | 3000 | 179.0                    | 8.4                      | 3.2     | 3.2     | 1.4     | 4.0        | 8.0       | Q3               |
| TPS3806J20DBVT | SOT-23          | DBV                | 6 | 250  | 179.0                    | 8.4                      | 3.2     | 3.2     | 1.4     | 4.0        | 8.0       | Q3               |





\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS3806I33DBVR | SOT-23       | DBV             | 6    | 3000 | 195.0       | 200.0      | 45.0        |
| TPS3806I33DBVT | SOT-23       | DBV             | 6    | 250  | 195.0       | 200.0      | 45.0        |
| TPS3806J20DBVR | SOT-23       | DBV             | 6    | 3000 | 195.0       | 200.0      | 45.0        |
| TPS3806J20DBVT | SOT-23       | DBV             | 6    | 250  | 195.0       | 200.0      | 45.0        |

### DBV (R-PDSO-G6)

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



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| Applications       |                           |  |  |
|--------------------|---------------------------|--|--|
| Audio              | www.ti.com/audio          |  |  |
| Automotive         | www.ti.com/automotive     |  |  |
| Broadband          | www.ti.com/broadband      |  |  |
| Digital Control    | www.ti.com/digitalcontrol |  |  |
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